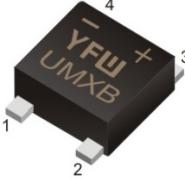


**1A SURFACE MOUNT GLASS PASSIVATED BRIDGE**
**RECTIFIER Reverse Voltage - 100 to 1000 V**
**Forward Current – 1A**
**FEATURES**

- ◆ High current capability
- ◆ Low forward voltage drop
- ◆ Glass Passivated Chip Junction
- ◆ Low power loss, high efficiency
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives


**MECHANICAL DATA**

- ◆ Case: UMB
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 45mg / 0.0016oz

	1. Input pin(~) 2. Input pin(~) 3. Output Anode(+) 4. Output Cathode(-)	UMB
<b>Marking Code</b>		
UM1B	UM1B	
UM2B	UM2B	
UM4B	UM4B	
UM6B	UM6B	
UM8B	UM8B	
UM10B	UM10B	

**Maximum Ratings and Electrical characteristics**

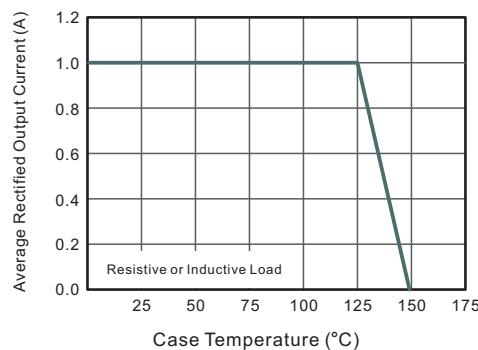
Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

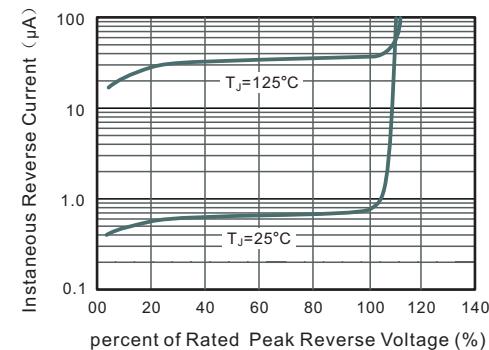
Parameter	Symbols	UM1B	UM2B	UM4B	UM6B	UM8B	UM10B	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	100	200	400	600	800	1000	<b>V</b>
Maximum RMS voltage	$V_{RMS}$	70	140	280	420	560	700	<b>V</b>
Maximum DC Blocking Voltage	$V_{DC}$	100	200	400	600	800	1000	<b>V</b>
Average Rectified Output Current at $T_c = 125^\circ C$	$I_o$	1						<b>A</b>
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load(JEDEC method)	$I_{FSM}$	35						<b>A</b>
Forward Voltage per element @ $I_F=0.4A$ @ $I_F=0.8A$	$V_F$	1.0 1.1						<b>V</b>
Maximum DC Reverse Current @ $T_A=25^\circ C$ at Rated DC Blocking Voltage @ $T_A=125^\circ C$	$I_R$	3 30						<b>μA</b>
Typical Junction Capacitance <small>(Note1)</small>	$C_J$	13						<b>pF</b>
Typical Thermal Resistance <small>(Note2)</small>	$R_{θJA}$	110						<b>°C/W</b>
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150						<b>°C</b>

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C
(2) Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

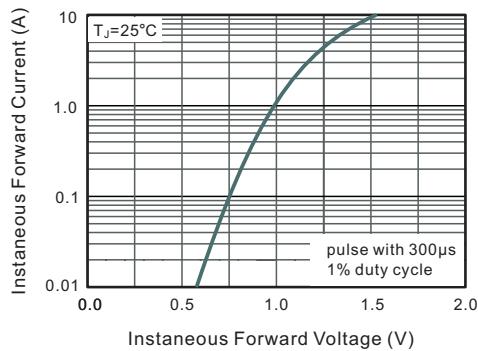
**Fig.1 Average Rectified Output Current Derating Curve**



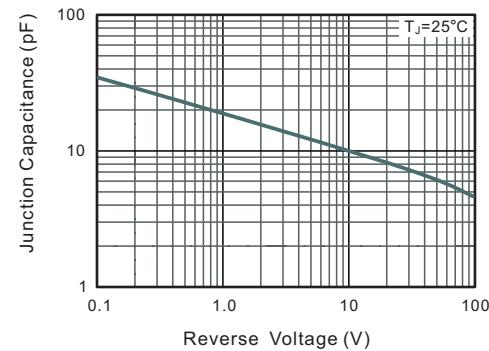
**Fig.2 Typical Reverse Characteristics**



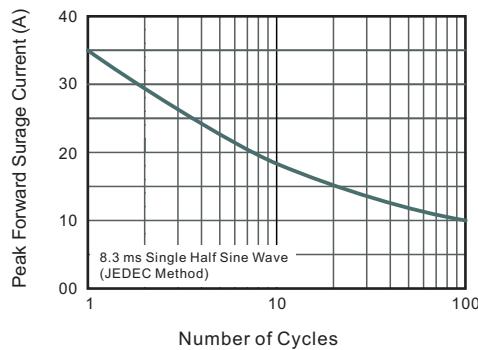
**Fig.3 Typical Instantaneous Forward Characteristics**



**Fig.4 Typical Junction Capacitance**



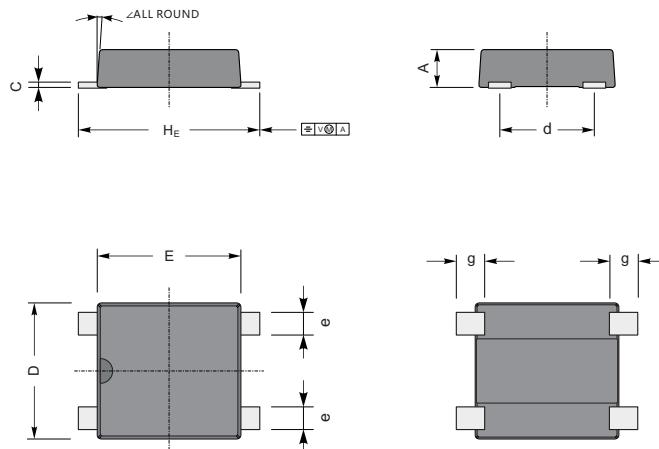
**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



## Package Outline

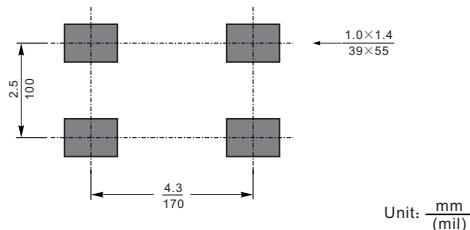
## UMB

Plastic surface mounted package; 4leads



UNIT		A	C	D	E	H <sub>E</sub>	g	d	e	<
mm	max	1.2	0.20	3.8	4.0	5.1	0.82	2.7	0.70	7°
	min	1.0	0.12	3.4	3.6	4.6	0.51	2.3	0.51	
mil	max	47	7.9	150	157	201	32	106	28	7°
	min	39	4.7	134	142	181	20	91	20	

### The recommended mounting pad size



### Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
UMB	Tape/Reel,13"reel	5000	EIA-481-1